

INFORMATION DISCLOSURE CITATION
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NEW

John MacNeil et al.

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FILING
July 15, 2003

GROUP
2813
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U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
TSP	A	5,514,604	05/07/1996	BROWN			
TSP	B	5,244,698	09/14/1993	ISHIHARA et al.			
TSP	C	4,647,472	03/03/1987	HIRAKI et al.			
TD	D	5,635,423	06/03/1997	HUANG et al.			
TSP	E	5,225,032	07/1993	GOLECKI			

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
TSP	F	EP 1 059 664 A2	12/13/2000	EPO				
TSP	G	WO 99/56310	04/11/1999	PCT				
TSP	H	WO 99/33102	07/01/1999	PCT				
TSP	I	WO 00/19498	04/06/2000	PCT				
TSP	J	WO 99/41423	08/19/1999	PCT				

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

TSP	K	"Dual-Damascene Challenges Dielectric Etch", Semiconductor International, August 1999, pages 69-72.					

EXAMINER

DATE CONSIDERED

1/24/05

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

